# **SWITCHMODE** <sup>™</sup> **Power Rectifiers**

These state-of-the-art devices are a series designed for use in switching power supplies, inverters and as free wheeling diodes.

#### **Features**

- Ultrafast 25 ns, 50 ns and 75 ns Recovery Times
- 175°C Operating Junction Temperature
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- Reverse Voltage to 600 V
- Shipped in Plastic Bags, 500 per Bag
- Available in Tape and Reel, 1500 per Reel, by Adding a "RLG" Suffix to the Part Number
- MUR460 available in Fan Fold Ammo Pak, 1000 per Box, by adding a "FFG" suffix to the part number
- These are Pb-Free Packages\*

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 1.1 Gram (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Cathode indicated by Polarity Band



# ON Semiconductor®

http://onsemi.com

# ULTRAFAST RECTIFIERS 4.0 AMPERES, 50–600 VOLTS





AXIAL LEAD CASE 267 STYLE 1

## **MARKING DIAGRAM**



A = Assembly Location

MUR4xx = Device Number

x = 05, 10, 15, 20, 40, 60

YY = Year WW = Work Week ■ Pb-Free Package

(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# **MAXIMUM RATINGS**

		MUR						
Rating	Symbol	405	410	415	420	440	460	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		50	100	150	200	400	600	V
Average Rectified Forward Current (Square Wave) (Mounting Method #3 Per Note 2)	I <sub>F(AV)</sub>	4.0 @ T <sub>A</sub> = 80°C		4.0 @ T <sub>A</sub> = 40°C		Α		
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, half wave, single phase, 60 Hz)	I <sub>FSM</sub>	125		110		Α		
Operating Junction Temperature & Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	- 65 to +175				°C		

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

# THERMAL CHARACTERISTICS

		MUR						
Rating	Symbol	405	410	415	420	440	460	Unit
Maximum Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	See Note 2		°C/W				

# **ELECTRICAL CHARACTERISTICS**

		MUR						
Rating	Symbol	405	410	415	420	440	460	Unit
Maximum Instantaneous Forward Voltage (Note 1) (i <sub>F</sub> = $3.0$ A, T <sub>J</sub> = $150^{\circ}$ C) (i <sub>F</sub> = $3.0$ A, T <sub>J</sub> = $25^{\circ}$ C) (i <sub>F</sub> = $4.0$ A, T <sub>J</sub> = $25^{\circ}$ C)	VF	0.71 0.88 0.89		1.05 1.25 1.28		V		
Maximum Instantaneous Reverse Current (Note 1) (Rated dc Voltage, $T_J = 150^{\circ}\text{C}$ ) (Rated dc Voltage, $T_J = 25^{\circ}\text{C}$ )	i <sub>R</sub>	150 5		250 10		μA		
Maximum Reverse Recovery Time (I <sub>F</sub> = 1.0 A, di/dt = 50 A/ $\mu$ s) (I <sub>F</sub> = 0.5 A, i <sub>R</sub> = 1.0 A, I <sub>REC</sub> = 0.25 A)	t <sub>rr</sub>	35 25				ns		
Maximum Forward Recovery Time (I <sub>F</sub> = 1.0 A, di/dt = 100 A/μs, Recovery to 1.0 V)	t <sub>fr</sub>	25		25 50		0	ns	
Controlled Avalanche Energy (Maximum)	W <sub>aval</sub>	5				mJ		

<sup>1.</sup> Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

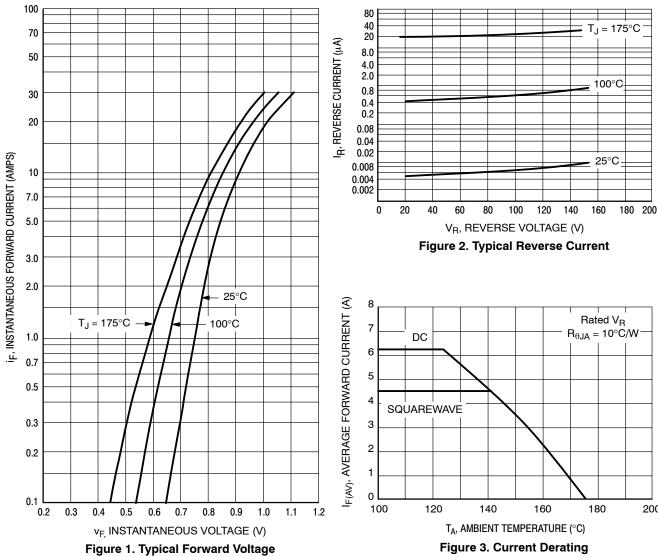
# **ORDERING INFORMATION**

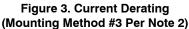
Device	Package	Shipping <sup>†</sup>
MUR405G	Axial Lead*	FOO Unite / Doc
MUR410G	Axial Lead*	500 Units / Bag
MUR410RLG	Axial Lead*	1500 / Tape & Reel
MUR415G	Axial Lead*	500 Units / Bag
MUR415RLG	Axial Lead*	1500 / Tape & Reel
MUR420G	Axial Lead*	500 Units / Bag
MUR420RLG	Axial Lead*	1500 / Tape & Reel
MUR440G	Axial Lead*	500 Units / Bag
MUR440RLG	Axial Lead*	1500 / Tape & Reel
MUR460G	Axial Lead*	500 Units / Bag
MUR460FFG	Axial Lead*	1000 Units / Box
MUR460RLG	Axial Lead*	1500 / Tape & Reel

<sup>†</sup>For information on tape and reel and ammo pak specifications, including part orientation, tape sizes and box dimensions, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

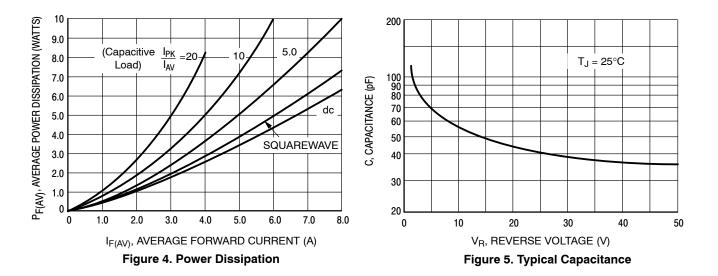
\*These packages are inherently Pb–Free.

# MUR405, MUR410, MUR415, MUR420

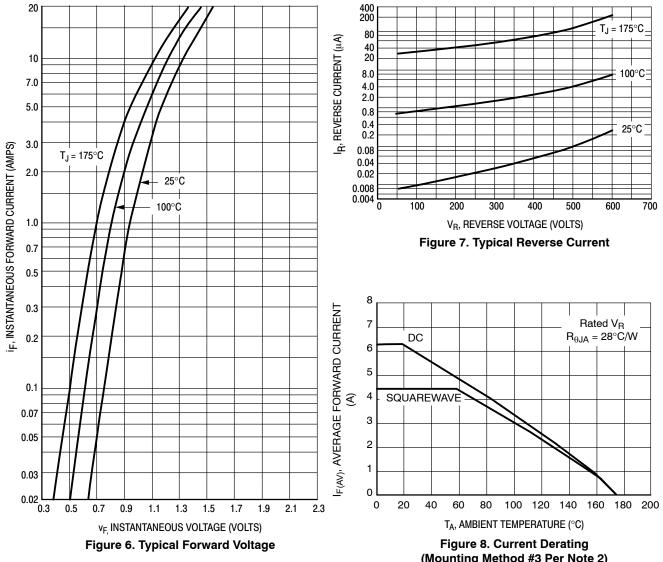




200



# MUR440, MUR460



(Mounting Method #3 Per Note 2)

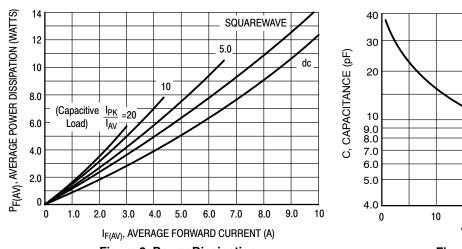


Figure 9. Power Dissipation

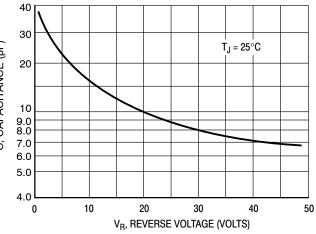


Figure 10. Typical Capacitance

# MUR440, MUR460

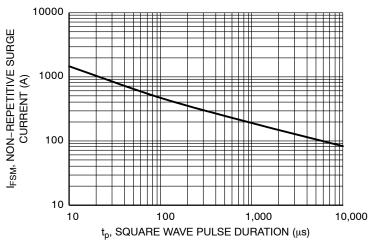


Figure 11. Typical Non-Repetitive Surge Current

<sup>\*</sup>Typical performance based on a limited sample size. ON Semiconductor does not guarantee ratings not listed in the Maximum Ratings table.

# NOTE 2 — AMBIENT MOUNTING DATA

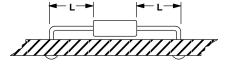
Data shown for thermal resistance junction—to—ambient  $(R_{\theta JA})$  for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

TYPICAL VALUES FOR  $\textbf{R}_{\theta \textbf{J} \textbf{A}}$  IN STILL AIR

Mounti	ng	Lead Length, L (IN)				
Method		1/8	1/4	1/2	3/4	Units
1		50	51	53	55	°C/W
2	$R_{\theta JA}$	58	59	61	63	°C/W
3			°C/W			

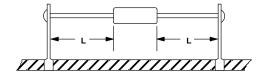
## **MOUNTING METHOD 1**

P.C. Board Where Available Copper Surface area is small.



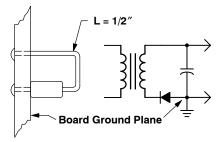
#### **MOUNTING METHOD 2**

Vector Push-In Terminals T-28



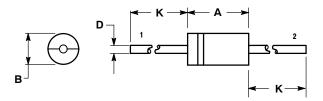
#### MOUNTING METHOD 3

P.C. Board with 1-1/2'' x 1-1/2'' Copper Surface



#### PACKAGE DIMENSIONS

**AXIAL LEAD** CASE 267-03 (DO-201AD) **ISSUE G** 



- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.

	INC	INCHES MILLI			
DIM	MIN	MAX	MIN	MAX	
Α	0.287	0.374	7.30	9.50	
В	0.189	0.209	4.80	5.30	
D	0.047	0.051	1.20	1.30	
K	1.000		25.40		

STYLE 1: PIN 1. CATHODE (POLARITY BAND)

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